

## N-Channel Super Junction Power MOSFET $\,\,{\rm IV}$

#### **General Description**

The series of devices use advanced trench gate super junction technology and design to provide excellent R<sub>DS(ON)</sub> with low gate charge. This super junction MOSFET fits the industry's AC-DC SMPS requirements for PFC, AC/DC power conversion, and industrial power applications.

#### Features

- Optimized body diode reverse recovery performance
- •Low on-resistance and low conduction losses
- Small package
- ●Ultra Low Gate Charge cause lower driving requirements
- ●100% Avalanche Tested
- ●ROHS compliant

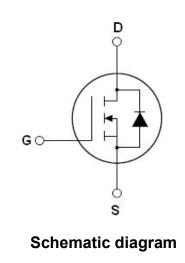
#### Application

- Power factor correction (PFC)
- Switched mode power supplies(SMPS)
- Uninterruptible Power Supply (UPS)
- LLC Half-bridge

#### Package Marking And Ordering Information

Device	Device Package	Marking
NCE70N600	NCE70N600 TO-220-3L	

# V<sub>DS min@Tjmax</sub> 750 V R<sub>DS(ON)TYP</sub>. 540 mΩ I<sub>D</sub> 7 A Qg 9.2 nC





#### Table 1. Absolute Maximum Ratings (Tc=25℃)

Parameter	Symbol	Value	Unit
Drain-Source Voltage (VGs=0V)	Vds	700	V
Gate-Source Voltage (V <sub>DS=0</sub> V) ,AC (f>1 Hz)	Vgs	±30	V
Gate-Source Voltage (V <sub>DS</sub> =0V) ,DC	Vgs	±20	V
Continuous Drain Current at Tc=25°C	I <sub>D (DC)</sub>	7	A
Continuous Drain Current at Tc=100°C	I <sub>D (DC)</sub>	4.9	A
Pulsed drain current <sup>(Note 1)</sup>	I <sub>DM (pluse)</sub>	21	A
Maximum Power Dissipation(Tc=25℃)	PD	93	W
Derate above 25°C		0.62	W/°C
Single pulse avalanche current <sup>(Note 2)</sup>	I <sub>AS</sub>	1.3	A
Reverse diode dv/dt, $V_{DS} \leq 480 \text{ V}, I_{SD} < I_D$	dv/dt	15	V/ns
Drain Source voltage slope, $V_{DS} \leqslant 480 V$	dv/dt	50	V/ns
Operating Junction and Storage Temperature Range	T <sub>J</sub> ,T <sub>STG</sub>	-55+175	°C



#### Table 2. Thermal Characteristic

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case (Maximum)	R <sub>thJC</sub>	1.61	°C /W
Thermal Resistance, Junction-to-Ambient (Maximum)	R <sub>thJA</sub>	62	°C /W

#### Table 3. Electrical Characteristics (TA=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
On/off states						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250uA	700			V
Zero Gate Voltage Drain Current(Tc=25°C)	I <sub>DSS</sub>	V <sub>DS</sub> =700V,V <sub>GS</sub> =0V			1	μA
Zero Gate Voltage Drain Current(Tc=125°C)	I <sub>DSS</sub>	V <sub>DS</sub> =700V,V <sub>GS</sub> =0V			50	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	$V_{GS}$ =±20V, $V_{DS}$ =0V			±200	nA
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS}=V_{GS}$ , $I_D=250$ uA	3		4	V
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =3.5A		540	610	mΩ
Dynamic Characteristics						
Gate Resistance	Rg	F=1MHZ, D-S short		36		Ω
Input Capacitance	Clss			538		pF
Output Capacitance	Coss	$V_{DS}$ =50V, $V_{GS}$ =0V,		21		pF
Reverse Transfer Capacitance	Crss	F=1MHz		4.5		pF
Total Gate Charge	Qg			9.2		nC
Gate-Source Charge	Q <sub>gs</sub>	V <sub>DS</sub> =520V,I <sub>D</sub> =3.5A,		2.2		nC
Gate-Drain Charge	Q <sub>gd</sub>	V <sub>GS</sub> =10V		3.1		nC
Gate plateau voltage	Vgp			5.4		V
Switching times						
Turn-on Delay Time	t <sub>d(on)</sub>			11		nS
Turn-on Rise Time	tr	V <sub>DD</sub> =520V,I <sub>D</sub> =3.5A, R <sub>G</sub> =4Ω,V <sub>GS</sub> =10V		6		nS
Turn-Off Delay Time	t <sub>d(off)</sub>			46		nS
Turn-Off Fall Time	t <sub>f</sub>			7		nS
Source- Drain Diode Characteristics	· · · ·					
Source-drain current(Body Diode)	I <sub>SD</sub>	T05°O			7	А
Pulsed-Source-drain current(Body Diode)	I <sub>SDM</sub>	Tc=25°C			21	А
Forward on voltage	V <sub>SD</sub>	Tj=25°C,I <sub>SD</sub> =7A,V <sub>GS</sub> =0V		0.9	1.1	V
Reverse Recovery Time	t <sub>rr</sub>			195		nS
Reverse Recovery Charge	Q <sub>rr</sub>			0.78		uC
Peak reverse recovery current	I <sub>rrm</sub>	di/dt=100A/µs		8		А

Notes: 1. Repetitive Rating: Pulse width limited by maximum junction temperature

2. Tj=25  $^\circ\!\mathrm{C}$  ,VDD=50V,VG=10V, R\_G=25 $\Omega$ 



#### **TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (curves)**

#### Figure1. Safe operating area

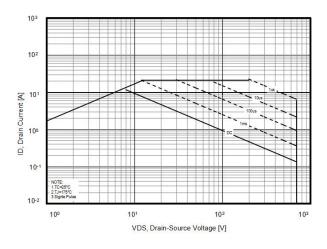


Figure3. Output characteristics

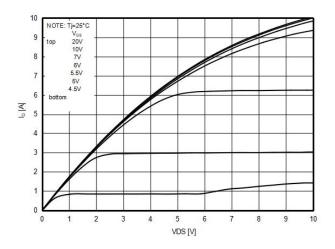
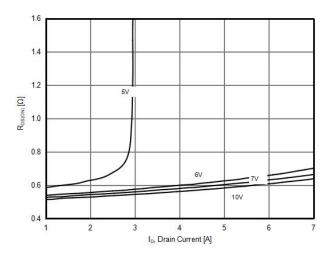


Figure5. Static drain-source on resistance



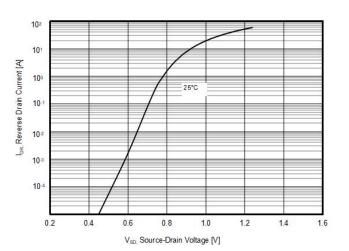


Figure2. Source-Drain Diode Forward Voltage

Figure4. Transfer characteristics

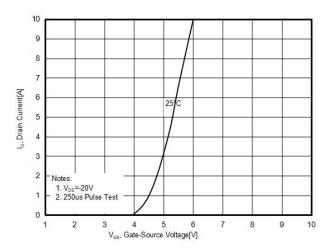
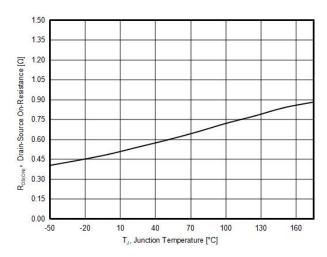


Figure6. RDS(ON) vs Junction Temperature



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Figure7. BV<sub>DSS</sub> vs Junction Temperature

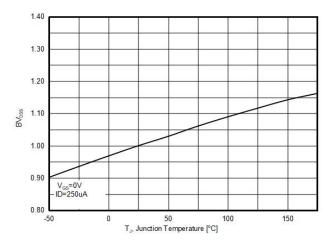


Figure9. Gate charge waveforms

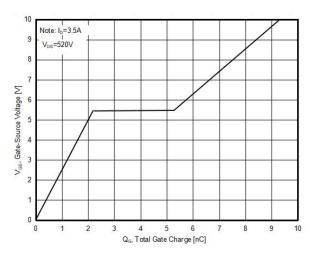


Figure8. Maximum I<sub>D</sub> vs Junction Temperature

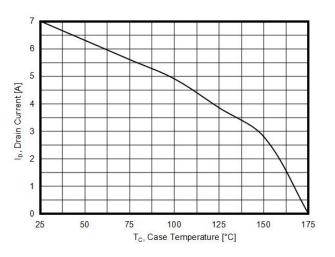
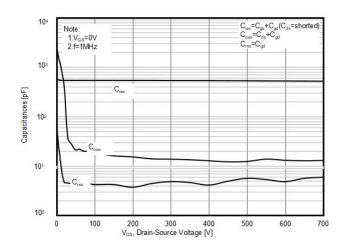


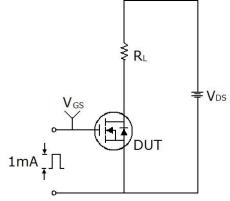
Figure10. Capacitance

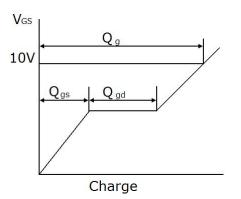




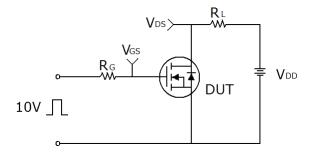
### **Test circuit**

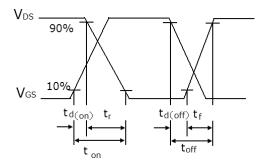
1) Gate charge test circuit & Waveform



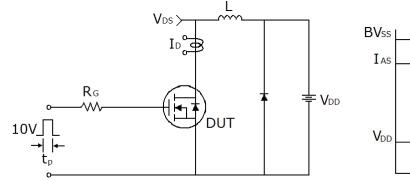


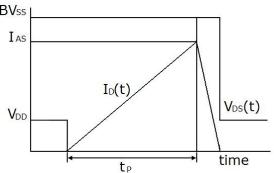
2) Switch Time Test Circuit:





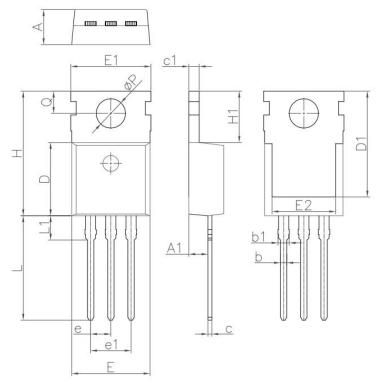
#### 3) Unclamped Inductive Switching Test Circuit & Waveforms







# **TO-220-E Package Information**



Symbol	Dimensions	In Millimeters	Dimensions In Inches		
	Min.	Max.	Min.	Max.	
А	4.20	4.60	0.165	0.181	
A1	2.25	2.55	0.089	0.100	
b	0.70	0.90	0.028	0.035	
b1	1.17	1.37	0.046	0.054	
С	0.33	0.65	0.013	0.026	
c1	1.20	1.40	0.047	0.055	
D	8.95	9.75	3.524	3.839	
D1	13.10	13.50	5.157	5.315	
E	9.74	10.04	3.835	3.953	
E1	9.91	10.25	3.902	4.035	
E2	7.90	8.10	3.110	3.189	
е	2.54BSC		0.100BSC		
e1	5.08	5.08BSC		BSC	
Н	15.45	15.85	6.083	6.240	
H1	6.30	6.60	2.480	2.598	
L	12.90	13.40	5.079	5.276	
L1	2.85	3.25	1.122	1.280	
Q	2.65	2.95	1.043	1.161	
ΦΡ	3.40	3.80	1.339	1.496	



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